## Power MOSFET

| PRODUCT SUMMARY |  |  |
| :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{DS}}(\mathrm{V})$ | 1000 |  |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}(\Omega)$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 5.0 |
| $\mathrm{Q}_{\mathrm{g}}($ Max. $)(\mathrm{nC})$ | 80 |  |
| $\mathrm{Q}_{\mathrm{gs}}(\mathrm{nC})$ | 10 |  |
| $\mathrm{Q}_{\mathrm{gd}}(\mathrm{nC})$ | 10 |  |
| Configuration | 42 |  |
| Single |  |  |



N-Channel MOSFET

## FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching

RoHS*

- Ease of Paralleling
- Simple Drive Requirements
- Lead (Pb)-free Available


## DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.
The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W . The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION |  |
| :--- | :--- |
| Package | TO-220 |
| Lead (Pb)-free | IRFBG30PbF |
|  | SnPb |
| SnFBG30-E3 |  |
|  | IRFBG30 |
|  | SiHFBG30 |

ABSOLUTE MAXIMUM RATINGS $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, unless otherwise noted

| PARAMETER |  |  | SYMBOL | LIMIT | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Drain-Source Voltage |  |  | $\mathrm{V}_{\mathrm{DS}}$ | 1000 | V |
| Gate-Source Voltage |  |  | $\mathrm{V}_{\mathrm{GS}}$ | $\pm 20$ |  |
| Continuous Drain Current | $\mathrm{V}_{\mathrm{GS}}$ at 10 V | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | ID | 3.1 | A |
|  |  | $\mathrm{T}_{\mathrm{C}}=10{ }^{\circ} \mathrm{C}$ |  | 2.0 |  |
| Pulsed Drain Current ${ }^{\text {a }}$ |  |  | $\mathrm{I}_{\mathrm{DM}}$ | 12 |  |
| Linear Derating Factor |  |  |  | 1.0 | W/ ${ }^{\circ} \mathrm{C}$ |
| Single Pulse Avalanche Energy ${ }^{\text {b }}$ |  |  | $\mathrm{E}_{\text {AS }}$ | 280 | mJ |
| Repetitive Avalanche Current ${ }^{\text {a }}$ |  |  | $\mathrm{I}_{\text {AR }}$ | 3.1 | A |
| Repetitive Avalanche Energy ${ }^{\text {a }}$ |  |  | $\mathrm{E}_{\text {AR }}$ | 13 | mJ |
| Maximum Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  | $\mathrm{P}_{\mathrm{D}}$ | 125 | W |
| Peak Diode Recovery dV/dtc |  |  | dV/dt | 1.0 | $\mathrm{V} / \mathrm{ns}$ |
| Operating Junction and Storage Temperature Range |  |  | $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {stg }}$ | -55 to + 150 | ${ }^{\circ} \mathrm{C}$ |
| Soldering Recommendations (Peak Temperature) | for 10 s |  |  | $300{ }^{\text {d }}$ |  |
| Mounting Torque | 6-32 or M3 screw |  |  | 10 | lbf . in |
|  |  |  |  | 1.1 | $\mathrm{N} \cdot \mathrm{m}$ |

## Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. $\mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}$, starting $\mathrm{T}_{J}=25^{\circ} \mathrm{C}, \mathrm{L}=55 \mathrm{mH}, \mathrm{R}_{\mathrm{G}}=25 \Omega, \mathrm{I}_{\mathrm{AS}}=3.1 \mathrm{~A}$ (see fig. 12).
c. $\mathrm{I}_{\mathrm{SD}} \leq 3.1 \mathrm{~A}, \mathrm{dl} / \mathrm{dt} \leq 80 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{DD}} \leq 600, \mathrm{~T}_{\mathrm{J}} \leq 150^{\circ} \mathrm{C}$.
d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

| THERMAL RESISTANCE RATINGS |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum Junction-to-Ambient | $\mathrm{R}_{\mathrm{thJA}}$ | - | 62 |  |
| Case-to-Sink, Flat, Greased Surface | $\mathrm{R}_{\mathrm{thcs}}$ | 0.50 | - |  |
| Maximum Junction-to-Case (Drain) | $\mathrm{R}_{\mathrm{thJc}}$ | - | 1.0 |  |



## Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width $\leq 300 \mu \mathrm{~s}$; duty cycle $\leq 2 \%$.

TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted

$V_{D S}$, Drain-to-Source Voltage (volts)
Fig. 1 - Typical Output Characteristics, $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$

$V_{D S}$, Drain-to-Source Voltage (volts)
Fig. 3 - Fig. 2 - Typical Output Characteristics, $\mathrm{T}_{\mathrm{C}}=150^{\circ} \mathrm{C}$

$V_{G S}$, Gate-to-Source Voltage (volts)
Fig. 3 - Typical Transfer Characteristics


Fig. 4 - Normalized On-Resistance vs. Temperature


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

$V_{S D}$, Source-to-Drain Voltage (volts)
Fig. 7 - Typical Source-Drain Diode Forward Voltage


Fig. 8 - Maximum Safe Operating Area


Fig. 9 - Maximum Drain Current vs. Case Temperature


Fig. 10a - Switching Time Test Circuit


Fig. 10b - Switching Time Waveforms


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case


Fig. 12a - Unclamped Inductive Test Circuit


Fig. 12b - Unclamped Inductive Waveforms


Fig. 12c - Maximum Avalanche Energy vs. Drain Current


Fig. 13a - Basic Gate Charge Waveform


Fig. 13b - Gate Charge Test Circuit

## Peak Diode Recovery dV/dt Test Circuit



* $\mathrm{V}_{\mathrm{GS}}=5 \mathrm{~V}$ for logic level devices

Fig. 14 - For N-Channel

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